# TOSHIBA

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE ( $L^2-\pi$ -MOSV)

# 2 S K 2 9 6 1

HIGH SPEED SWITCHING APPLICATIONS

RELAY DRIVE, MOTOR DRIVE AND DC-DC CONVERTER APPLICATION

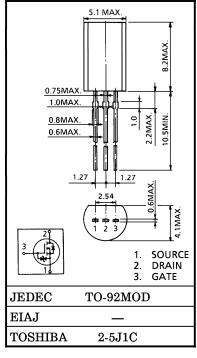
- :  $R_{DS(ON)} = 0.2\Omega$  (Typ.) Low Drain-Source ON Resistance
- High Forward Transfer Admittance :  $|Y_{fs}| = 2.0S$  (Typ.)
- Low Leakage Current :  $I_{DSS} = 100 \mu A$  (V<sub>DS</sub> = 60V)
- Enhancement-Mode :  $V_{th} = 0.8 \sim 2.0 V (V_{DS} = 10V, I_D = 1mA)$

#### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERIS	SYMBOL	RATING	UNIT	
Drain-Source Voltage	VDSS	60	V	
Drain-Gate Voltage (RG	VDGR	60	V	
Gate-Source Voltage	VGSS	$\pm 20$	V	
Drain Current	DC	ID	2.0	А
	Pulse	I <sub>DP</sub>	6.0	A
Drain Power Dissipation	PD	0.9	W	
Channel Temperature	T <sub>ch</sub>	150	°C	
Storage Temperature Ra	T <sub>stg</sub>	$-55 \sim 150$	°C	

### INDUSTRIAL APPLICATIONS

Unit in mm



#### THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Ambient	R <sub>th (ch-a)</sub>	138	°C/W

This transistor is an electrostatic sensitive device. Please handle with caution.

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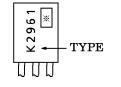
ELECTRICAL	CHARACTERISTICS	(Ta = 25°C)
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CHARA	CTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage	e Current	IGSS	$V_{GS} = \pm 16V, V_{DS} = 0V$		—	±10	$\mu \mathbf{A}$
Drain Cut-of	f Current	IDSS	$V_{DS} = 60V, V_{GS} = 0V$		—	100	$\mu \mathbf{A}$
Drain-Source Voltage	Breakdown	V (BR) DSS	$I_D=10mA$ , $V_{GS}=0V$	60	_	_	v
Gate Thresho	old Voltage	V <sub>th</sub>	$V_{DS} = 10V, I_D = 1mA$	0.8	—	2.0	V
Drain-Source	ON Resistance	R <sub>DS (ON)</sub>	$V_{GS}=4V, I_{D}=1.0A$ $V_{GS}=10V, I_{D}=1.0A$		0.26	0.38	Ω
Forward Tran Admittance	nsfer	Y <sub>fs</sub>	$V_{\rm DS} = 10V, I_{\rm D} = 1.0A$	1.0	2.0	_	s
Input Capaci	tance	Ciss		_	170	—	
Reverse Transfer Capacitance		C <sub>rss</sub>	$V_{DS}=10V, V_{GS}=0V$ f=1MHz	_	25	_	pF
Output Capacitance		C <sub>oss</sub>	1		75	_	
Switching Time Fall Ti	Rise Time	tr	$V_{GS} \stackrel{10V}{}_{0V} \int_{C} \stackrel{I_{D}=1A}{}_{VOUT} V_{OUT}$ $V_{IN} : t_{r}, t_{f} < 5ns,$ $Duty \leq 1\%, t_{w} = 10\mu s$		10	_	
	Turn-on Time	t <sub>on</sub>		_	15	_	ns
	Fall Time	tf		_	50	_	115
	Turn-off Time	toff		_	170	_	
Total Gate Charge (Gate- Source Plus Gate-Drain)		$\mathbf{Q}_{\mathbf{g}}$	$V_{DD} \Rightarrow 48V, V_{GS} = 10V$ $I_D = 2A$	_	5.8	_	nC
Gate-Source Charge		$Q_{gs}$		_	4.1	_	
Gate-Drain ("Miller") Charge		$\mathbf{Q}_{\mathbf{gd}}$		_	1.7	_	

## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I <sub>DR</sub>	_	_	_	2.0	A
Pulse Drain Reverse Current	IDRP	—	_	—	6.0	Α
Diode Forward Voltage	V <sub>DSF</sub>	$I_{DR}=2A, V_{GS}=0V$		—	-1.5	V
Reverse Recovery Time	t <sub>rr</sub>	$I_{DR}=2A, V_{GS}=0V$		45	—	ns
Reverse Recovery Charge	$Q_{rr}$	$dI_{DR}/dt = 50A/\mu s$		40.5	_	nC

#### MARKING



<sup>∞</sup> Lot Number

Month (Starting from Alphabet A) Year (Last Number of the Christian Era)

